- **Members of the Texas Instruments *Widebus+*™ Family**
- **State-of-the-Art *EPIC*-IIB™ BiCMOS Design Significantly Reduces Power Dissipation**
- **Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17**
- **Typical V_{OLP} (Output Ground Bounce) < 0.8 V at V_{CC} = 5 V, T_A = 25°C**

- **Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise**
- **High-Drive Outputs (-32-mA I_{OH}, 64-mA I_{OL})**
- **Bus-Hold Inputs Eliminate the Need for External Pullup Resistors**
- **Packaged in 100-Pin Plastic Thin Quad Flat (PZ) Package With 14×14-mm Body Using 0.5-mm Lead Pitch**

SN74ABT32245 . . . PZ PACKAGE
(TOP VIEW)
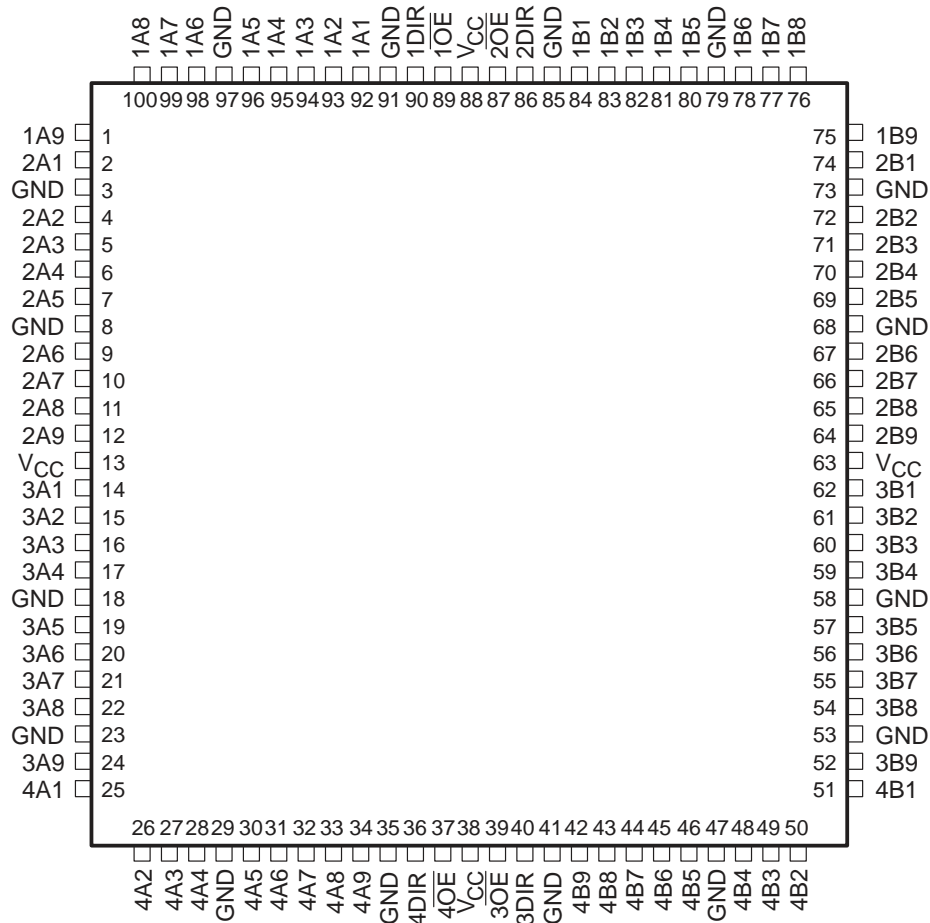
description

The ′ABT32245 are 36-bit (quad 9-bit) noninverting 3-state transceivers designed for synchronous two-way communication between data buses. The control-function implementation minimizes external timing requirements.

These devices can be used as four 9-bit transceivers, two 18-bit transceivers, or one 36-bit transceiver. They allow data transmission from the A bus to the B bus or from the B bus to the A bus, depending upon the logic level at the direction-control (DIR) inputs. The output-enable ($\overline{OE}$) inputs can be used to disable the device so that the buses are effectively isolated.

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description (continued)

To ensure the high-impedance state during power up or power down, $\overline{OE}$ should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Active bus-hold circuitry holds unused or floating data inputs at a valid logic level.

The SN54ABT32245 is characterized for operation over the full military temperature range of $-55°C$ to $125°C$. The SN74ABT32245 is characterized for operation from $-40°C$ to $85°C$.

FUNCTION TABLE
(each 9-bit section)

INPUTS		OPERATION
$\overline{OE}$	DIR	
L	L	B data to A bus
L	H	A data to B bus
H	X	Isolation

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logic diagram (positive logic)
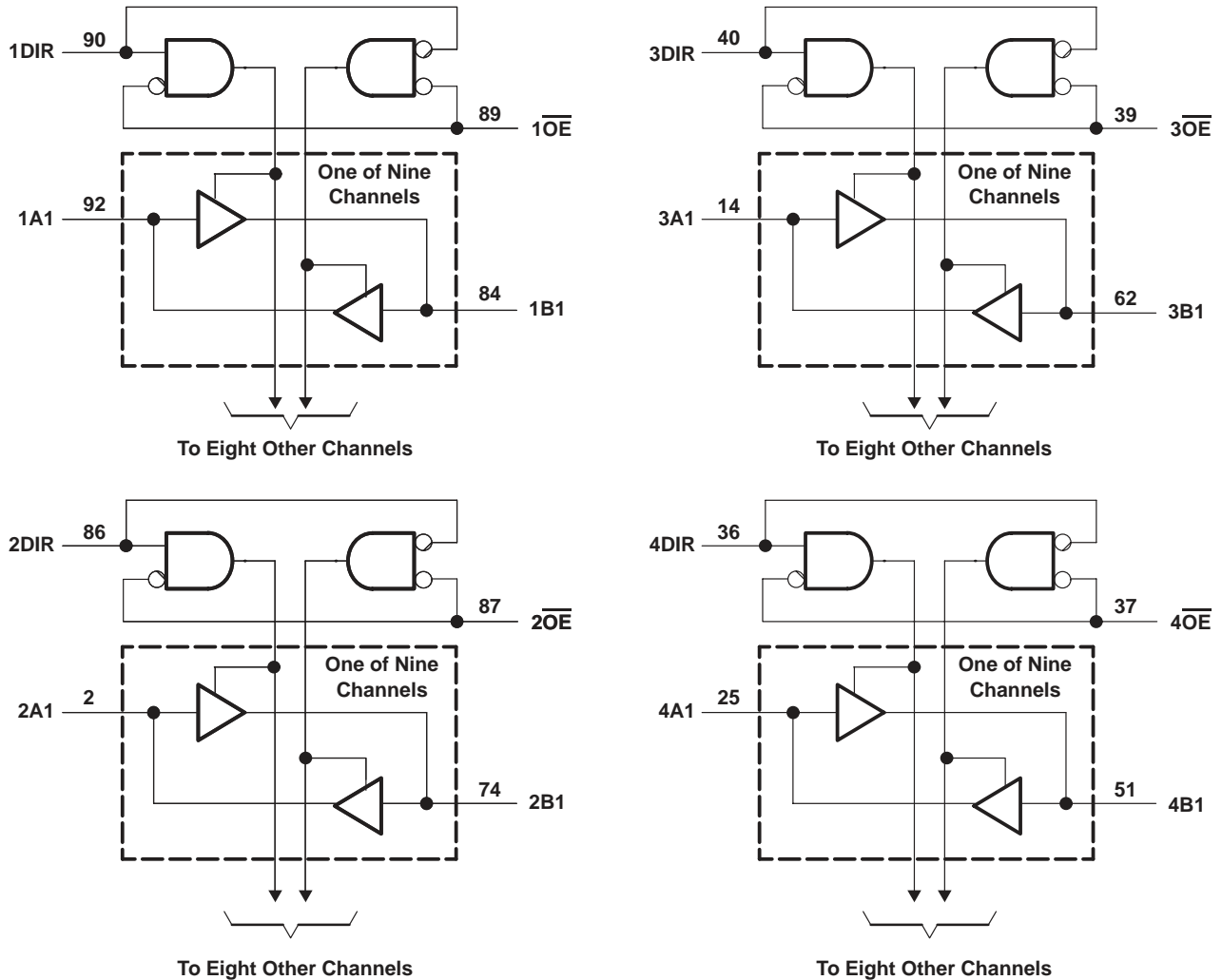
absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC}	−0.5 V to 7 V
Input voltage range, V_I (except I/O ports) (see Note 1)	−0.5 V to 7 V
Voltage range applied to any output in the high state or power-off state, V_O	−0.5 V to 5.5 V
Current into any output in the low state, I_O: SN54ABT32245	96 mA
SN74ABT32245	128 mA
Input clamp current, I_{IK} ($V_I < 0$)	−18 mA
Output clamp current, I_{OK} ($V_O < 0$)	−50 mA
Maximum power dissipation at $T_A = 55°C$ (in still air) (see Note 2)	1.2 W
Storage temperature range	−65°C to 150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 75 mils. For more information, refer to the *Package Thermal Considerations* application note in the 1994 *ABT Advanced BiCMOS Technology Data Book*, literature number SCBD002B.

recommended operating conditions

			SN54ABT32245		SN74ABT32245		UNIT
			MIN	MAX	MIN	MAX	
V_{CC}	Supply voltage		4.5	5.5	4.5	5.5	V
V_{IH}	High-level input voltage		2		2		V
V_{IL}	Low-level input voltage			0.8		0.8	V
V_I	Input voltage		0	V_{CC}	0	V_{CC}	V
I_{OH}	High-level output current			−24		−32	mA
I_{OL}	Low-level output current			48		64	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	Outputs enabled		10		10	ns/V
$\Delta t/\Delta V_{CC}$	Power-up ramp rate		200		200		µs/V
T_A	Operating free-air temperature		−55	125	−40	85	°C

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		SN54ABT32245 MIN	TYP†	MAX	SN74ABT32245 MIN	TYP†	MAX	UNIT
V_{IK}		V_{CC} = 4.5 V,	I_I = −18 mA			−1.2			−1.2	V
V_{OH}		V_{CC} = 4.5 V,	I_{OH} = −3 mA	2.5			2.5			V
		V_{CC} = 5 V,	I_{OH} = −3 mA	3			3			
		V_{CC} = 4.5 V	I_{OH} = −24 mA	2						
			I_{OH} = −32 mA				2			
V_{OL}		V_{CC} = 4.5 V	I_{OL} = 48 mA			0.55			0.55	V
			I_{OL} = 64 mA						0.55	
I_I	Control inputs	V_{CC} = 0 to 5.5 V,	V_I = V_{CC} or GND			±1			±1	µA
	A or B ports	V_{CC} = 2.1 V to 5.5 V,	V_I = V_{CC} or GND			±20			±20	
$I_{I(hold)}$	A or B ports	V_{CC} = 4.5 V	V_I = 0.8 V	100			100			µA
			V_I = 2 V	−100			−100			
I_{OZPU}‡		V_{CC} = 0 to 2.1 V, $\overline{OE}$ = X	V_O = 0.5 V to 2.7 V,			±50			±50	µA
I_{OZPD}‡		V_{CC} = 2.1 V to 0, $\overline{OE}$ = X	V_O = 0.5 V to 2.7 V,			±50			±50	µA
I_{OZH}§		V_{CC} = 2.1 V to 5.5 V,	V_O = 2.7 V, $\overline{OE}$ ≥ 2 V			10			10	µA
I_{OZL}§		V_{CC} = 2.1 V to 5.5 V,	V_O = 0.5 V, $\overline{OE}$ ≥ 2 V			−10			−10	µA
I_{off}		V_{CC} = 0,	V_I or V_O ≤ 4.5 V			±100			±100	µA
I_{CEX}		V_{CC} = 5.5 V,	V_O = 5.5 V, Outputs high			50			50	µA
I_O¶		V_{CC} = 5.5 V,	V_O = 2.5 V	−50	−100	−180	−50	−100	−180	mA
I_{CC}		V_{CC} = 5.5 V, I_O = 0, V_I = V_{CC} or GND	Outputs high			3			3	mA
			Outputs low			20			20	
			Outputs disabled			2			2	
ΔI_{CC}#		V_{CC} = 5.5 V, Other inputs at V_{CC} or GND	One input at 3.4 V,			1			1	mA
C_i	Control inputs	V_I = 2.5 V or 0.5 V			3.5			3.5		pF
C_{io}	A or B ports	V_O = 2.5 V or 0.5 V			9.5			9.5		pF

† All typical values are at V_{CC} = 5 V, T_A = 25°C.
‡ This parameter is specified by characterization.
§ The parameters I_{OZH} and I_{OZL} include the input leakage current.
¶ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.
# This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

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switching characteristics over recommended ranges of supply voltage and operating free-air temperature, C$_L$ = 50 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V$_{CC}$ = 5 V, T$_A$ = 25°C			SN54ABT32245		SN74ABT32245		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t$_{PLH}$	A or B	B or A	1.7	3.2	4.4	1.7	5.3	1.7	5	ns
t$_{PHL}$			1.7	3.3	4.6	1.7	5.3	1.7	5.2	
t$_{PZH}$	$\overline{OE}$	B or A	1.6	4.2	6.1	1.6	7.6	1.6	7.3	ns
t$_{PZL}$			2.7	5.2	7	2.7	8.2	2.7	8.1	
t$_{PHZ}$	OE	B or A	1.3	3.9	6.1	1.3	6.7	1.3	6.5	ns
t$_{PLZ}$			2	4.4	6.6	2	7.2	2	6.9	

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PARAMETER MEASUREMENT INFORMATION

LOAD CIRCUIT FOR OUTPUTS
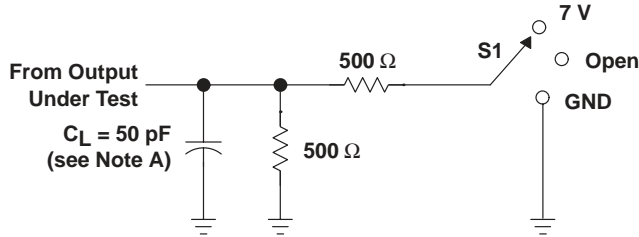
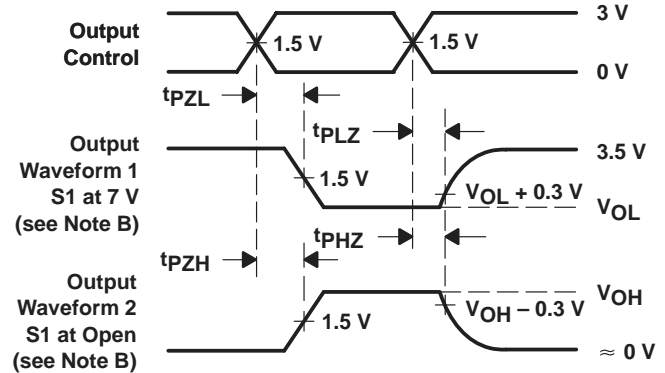| TEST	S1
t_{PLH}/t_{PHL}	Open
t_{PLZ}/t_{PZL}	7 V
t_{PHZ}/t_{PZH}	Open
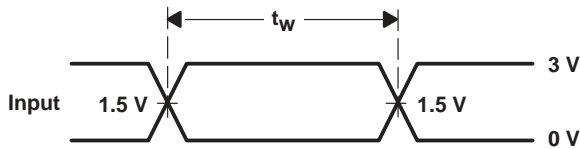
VOLTAGE WAVEFORMS
PULSE DURATION
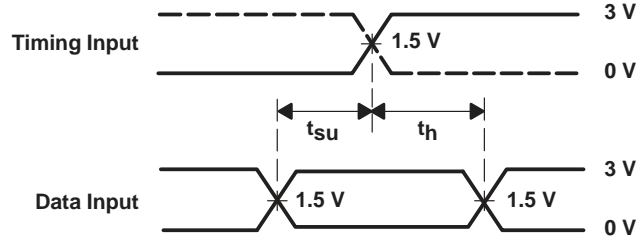
VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES
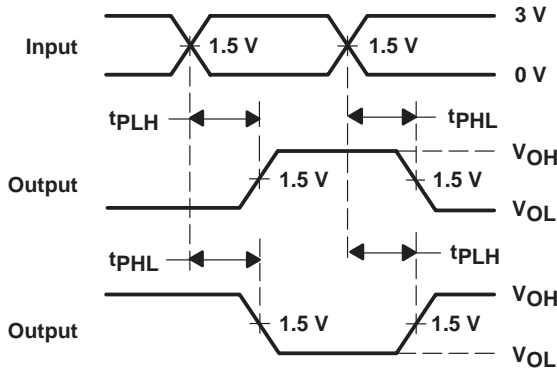
VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
INVERTING AND NONINVERTING OUTPUTS

VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

NOTES: A. C_L includes probe and jig capacitance.
      B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.
         Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
      C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z_O = 50 Ω, t_r ≤ 2.5 ns, t_f ≤ 2.5 ns.
      D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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